An Introduction to Knights Landing

Jason Sewall & TCG Micro

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Agenda

- Single-node parallelism
- Introduction to Knights Landing
  - MCDRAM
  - AVX-512
- Preparing for Knights Landing
  - SDE
  - Hardware as a Proxy
- Summary
Increasing parallelism in Xeon and Xeon Phi

<table>
<thead>
<tr>
<th>Core(s)</th>
<th>Threads</th>
<th>SIMD Width</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>2</td>
<td>4</td>
</tr>
<tr>
<td>2</td>
<td>2</td>
<td>8</td>
</tr>
<tr>
<td>128</td>
<td>128</td>
<td>128</td>
</tr>
</tbody>
</table>

*Product specification for launched and shipped products available on ark.intel.com.

1. Not launched.
Moore’s Law and Parallelism

35 YEARS OF MICROPROCESSOR TREND DATA

Original data collected and plotted by M. Horowitz, F. Labonte, O. Shacham, K. Olukotun, L. Hammond and C. Batten
Dotted line extrapolations by C. Moore
Parallelism and Performance

Peak GFLOP/s in Single Precision
- Clock Rate x Cores x Ops/Cycle x SIMD

2 x Intel® Xeon® Processor E5-2670v2
- 2.5 GHz x 2 x 10 cores x 2 ops x 8 SIMD
  = 800 GFLOP/s

Intel® Xeon Phi™ Coprocessor 7120P
- 1.24 GHz x 61 cores x 2 ops x 16 SIMD
  = 2420.48 GFLOP/s

Note the logarithmic scale on the y-axis.
ST = Single Thread, MT = Multiple Threads
On modern hardware, Performance = Parallelism

Flat programming model on parallel hardware is not effective.

Parallel programming is not optional.

Codes need to be made parallel (“modernized”) before they can be tuned for the hardware (“optimized”).

Note the logarithmic scale on the y-axis.
ST = Single Thread, MT = Multiple Threads
Parallel concepts

Parallel computing uses multiple computing units in parallel to
- Solve problems more quickly than a single processor (“strong scaling”)
- Solve larger problems in the same time as a single processor (“weak scaling”)
- Solve problems with higher fidelity

High-performance parallel computing is hard and requires
- Finding enough parallelism
- Deciding the optimal granularity, locality and load balance
- Coordination and synchronization

Real-world applications/algorithms are complex and often hierarchical: monolithic programming model is limited
Amdahl’s Law

\[ S(N) = \frac{1}{(1 - P) + \frac{P}{N}} \]

where:
- \( S(N) \) = speedup on \( N \) processors
- \( P \) = fraction of code that can be parallelised
- \( N \) = number of processors

The speedup of “strong scaling” applications is governed by Amdahl’s Law.

As \( N \to \infty \), \( S(N) \to \frac{1}{(1-P)} \).
Impact of Amdahl’s Law

![Graph showing the impact of Amdahl's Law with different values of P (0.5 to 1) on speedup versus number of processors. The graph demonstrates how the speedup increases with the number of processors, but the rate of increase decreases as P decreases.]
Amdahl’s Law in Practice

• Assumption that $P$ and $N$ are independent is unrealistic.
  – Strong Scaling:
    All-to-all communication costs increase with $N$.
    For sufficiently large $N$, applications will start to slow down again!
  – Weak Scaling:
    Increasing problem size may not linearly increase compute time.

• Key takeaway from both laws:
  maximize $P$ to maximize efficiency and performance at scale.

• Parallelism “bolted on” to scalar applications will not scale.
What is Knights Landing?
Knights Landing Overview

Chip: 36 Tiles interconnected by 2D Mesh
Tile: 2 Cores + 2 VPU/core + 1 MB L2

Memory: MCDRAM: 16 GB on-package; High BW
DDR4: 6 channels @ 2400 up to 384GB
IO: 36 lanes PCIe Gen3. 4 lanes of DMI for chipset
Node: 1-Socket only
Fabric: Omni-Path on-package (not shown)

Vector Peak Perf: 3+TF DP and 6+TF SP Flops
Scalar Perf: ~3x over Knights Corner
Streams Triad (GB/s): MCDRAM: 400+; DDR: 90+

Source: Intel. All products, computer systems, dates and figures specified are preliminary based on current expectations, and are subject to change without notice. KNL data are preliminary based on current expectations and are subject to change without notice. Binary compatible with Intel Xeon processors using Haswell Instruction Set (except TSX). *Bandwidth numbers are based on STREAM-like memory access pattern when MCDRAM used as L1 memory. Results have been estimated based on internal Intel analysis and are not based on actual program results only. Any difference in system performance may vary based on different system configurations.
**Many Trailblazing Improvements in KNL**

<table>
<thead>
<tr>
<th>Improvements</th>
<th>What/Why</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Self Boot Processor</strong></td>
<td>No PCIe bottleneck</td>
</tr>
<tr>
<td><strong>Binary Compatibility with Xeon</strong></td>
<td>Runs all legacy software. No recompilation.</td>
</tr>
<tr>
<td><strong>New Core: Atom™ based</strong></td>
<td>~3x higher ST performance over KNC</td>
</tr>
<tr>
<td><strong>Improved Vector density</strong></td>
<td>3+ TFLOPS (DP) peak per chip</td>
</tr>
<tr>
<td><strong>New AVX 512 ISA</strong></td>
<td>New 512-bit Vector ISA with Masks</td>
</tr>
<tr>
<td><strong>Scatter/Gather Engine</strong></td>
<td>Hardware support for gather and scatter</td>
</tr>
<tr>
<td><strong>New memory technology:</strong> MCDRAM + DDR</td>
<td>Large High Bandwidth Memory $\rightarrow$ MCDRAM</td>
</tr>
<tr>
<td></td>
<td>Huge bulk memory $\rightarrow$ DDR</td>
</tr>
<tr>
<td><strong>New on-die interconnect: Mesh</strong></td>
<td>High BW connection between cores and memory</td>
</tr>
<tr>
<td><strong>Integrated Fabric: Omni-Path</strong></td>
<td>Better scalability to large systems. Lower Cost</td>
</tr>
</tbody>
</table>

Software and workloads used in performance tests may have been optimized for performance only on Intel microprocessors. Performance tests, such as SYSmark and MobileMark, are measured using specific computer systems, components, software, operations and functions. Any change to any of those factors may cause the results to vary. You should consult other information and performance tests in order to fully evaluate your contemplated purchases, including the performance of that product when combined with other products. For more information go to [http://www.intel.com/performance](http://www.intel.com/performance). Results have been estimated based on internal Intel analysis and are provided for informational purposes only. Any difference in system hardware or software design or configuration may affect actual performance.
KNL ISA

KNL implements all legacy instructions
- Legacy binary runs w/o recompilation
- KNC binary requires recompilation

KNL introduces AVX-512 Extensions
- 512-bit FP/Integer Vectors
- 32 registers, & 8 mask registers
- Gather/Scatter

Conflict Detection: Improves Vectorization
Prefetch: Gather and Scatter Prefetch
Exponential and Reciprocal Instructions

1. Previous Code name Intel® Xeon® processors
2. Xeon Phi = Intel® Xeon Phi™ processor
KNL Tile: 2 Cores, each with 2 VPU
1M L2 shared between two Cores

Core: Changed from Knights Corner (KNC) to KNL. Based on 2-wide OoO Silvermont™ Microarchitecture, but with many changes for HPC.
4 thread/core. Deeper OoO. Better RAS. Higher bandwidth. Larger TLBs.

2 VPU: 2x AVX512 units. 32SP/16DP per unit. X87, SSE, AVX1, AVX2 and EMU

L2: 1MB 16-way. 1 Line Read and ½ Line Write per cycle. Coherent across all Tiles

CHA: Caching/Home Agent. Distributed Tag Directory to keep L2s coherent. MESIF protocol. 2D-Mesh connections for Tile
Core & VPU

- Out-of-order core w/ 4 SMT threads
- VPU tightly integrated with core pipeline

- 2-wide Decode/Rename/Retire
- ROB-based renaming. 72-entry ROB & Rename Buffers
- Up to 6-wide at execution
- Int and FP RS OoO.
- MEM RS inorder with OoO completion. Recycle Buffer holds memory ops waiting for completion.
- Int and Mem RS hold source data. FP RS does not.

- 2x 64B Load & 1 64B Store ports in Dcache.
- 1st level uTLB: 64 entries
- 2nd level dTLB: 256 4K, 128 2M, 16 1G pages

- L1 Prefetcher (IPP) and L2 Prefetcher.
- 46/48 PA/VA bits
- Fast unaligned and cache-line split support.
- Fast Gather/Scatter support
Threading

- 4 Threads per core. Simultaneous Multithreading.

- Core resources **shared** or **dynamically repartitioned** between active threads
  - ROB, Rename Buffers, RS: Dynamically partitioned
  - Caches, TLBs: Shared
  - E.g., 1 thread active → uses full resources of the core

- Several Thread Selection points in the pipeline. (红星)
  - Maximize throughput while being fair.
  - Account for available resources, stalls and forward progress
KNL Mesh Interconnect

Mesh of Rings
- Every row and column is a (half) ring
- YX routing: Go in Y → Turn → Go in X
- Messages arbitrate at injection and on turn

Cache Coherent Interconnect
- MESIF protocol (F = Forward)
- Distributed directory to filter snoops

Three Cluster Modes
(1) All-to-All (2) Quadrant (3) Sub-NUMA Clustering
Cluster Mode: All-to-All

Address uniformly hashed across all distributed directories

No affinity between Tile, Directory and Memory

Most general mode. Lower performance than other modes.

Typical Read L2 miss
1. L2 miss encountered
2. Send request to the distributed directory
3. Miss in the directory. Forward to memory
4. Memory sends the data to the requestor
Cluster Mode: Quadrant

Chip divided into four virtual Quadrants

Address hashed to a Directory in the same quadrant as the Memory

Affinity between the Directory and Memory

Lower latency and higher BW than all-to-all. SW Transparent.

1) L2 miss, 2) Directory access, 3) Memory access, 4) Data return
Cluster Mode: Sub-NUMA Clustering (SNC)

Each Quadrant (Cluster) exposed as a separate NUMA domain to OS.

Looks analogous to 4-Socket Xeon

Affinity between Tile, Directory and Memory

Local communication. Lowest latency of all modes.

SW needs to NUMA optimize to get benefit.

1) L2 miss, 2) Directory access, 3) Memory access, 4) Data return
MCDRAM Overview

- Large numbers of cores can consume large amounts of memory bandwidth.
- Knights Landing is equipped with 6 bidirectional DDR4 memory channels and MCDRAM.
- Memory requests are serviced by a mesh network maintaining cache coherence.
- MCDRAM can be configured as:
  1) a third level cache;
  2) as a flat, distinct region of memory; or
  3) as a hybrid, somewhere in-between.
MCDRAM: Cache vs Flat Mode

<table>
<thead>
<tr>
<th></th>
<th>DDR Only</th>
<th>MCDRAM as Cache</th>
<th>MCDRAM Only</th>
<th>Flat DDR + MCDRAM</th>
<th>Hybrid</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Software Effort</strong></td>
<td></td>
<td></td>
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<tr>
<td></td>
<td>No software changes required</td>
<td></td>
<td>Change allocations for bandwidth-critical data.</td>
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<tr>
<td><strong>Performance</strong></td>
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- Recommended
- Limited memory capacity
- Optimal HW utilization + opportunity for new algorithms
- Not peak performance.
MCDRAM as Cache

Upside
- No software modifications required.
- Bandwidth benefit.

Downside
- Latency hit to DDR.
- Limited sustained bandwidth.
- All memory is transferred: DDR -> MCDRAM -> L2.
- Less addressable memory.

MCDRAM in Flat Mode

Upside
- Maximum bandwidth and latency performance.
- Maximum addressable memory.
- Isolate MCDRAM for HPC application use only.

Downside
- Software modifications required to use DDR and MCDRAM in the same application.
- Which data structures should go where?
- MCDRAM is a limited resource and tracking it adds complexity.
Flat MCDRAM: SW Architecture

MCDRAM exposed as a separate NUMA node

Memory allocated in DDR by default → Keeps non-critical data out of MCDRAM.

Apps explicitly allocate critical data in MCDRAM. Using two methods:

- “Fast Alloc” functions in High BW library ([https://github.com/memkind](https://github.com/memkind))
  - Built on top to existing libnuma API
- “FASTMEM” Compiler Annotation for Intel Fortran

Flat MCDRAM with existing NUMA support in Legacy OS
A New ISA: AVX-512

- Knights Landing is the first micro-architecture to support AVX-512.
  - AVX-512F, AVX-512 CDI, AVX-512 ERI, AVX-512 PFI

- Differences from AVX2:
  - 32 x 512 bit SIMD registers (zmm0 – zmm31)
  - Dedicated mask registers (k0 – k7)
  - New instructions: gather/scatter (F), expand/compress (F), conflict detection (CDI), exponential and reciprocal (ERI), prefetch (PFI)

- Differences from IMCI (Knights Corner ISA):
  - Backwards compatible with SSE/AVX.
  - New instructions: conflict detection (CDI)
Conflict Detection Instructions (CDI)

- Sparse updates (e.g. \(A[B[i]]++\)) are common, but hard to vectorize.

- Naively vectorized, loops look like this:

  ```
  for (i=0; i<N; i+=16) {
      index = vload &B[i]                // Load 16 B[i]
      old_val = gather A, index          // Grab A[B[i]]
      new_val = vadd old_val, some_value // Compute new values
      scatter A, index, new_val          // Update A[B[i]]
  }
  ```

- Code is **wrong** if any values within “index” are duplicated.
Conflict Detection Instructions (CDI)

- AVX-512 CDI introduces three new instructions:
  - `vpconflict{d,q} zmm1 {k1}, zmm2/mem`
    Compares (for equality) each element in `zmm2` with “earlier” elements and outputs bit vector.
  - `vpbroadcastm{b2q,w2d} zmm1 {k0}, to_do`
  - `vplzcnt{d,q}`
  - `vptestnm{d,q} k2 {k1}, zmm1, zmm2/mem`
    (from AVX-512F)
    Manipulate bit vector from `vpconflict` to construct a useful mask.
Conflict Detection Instructions (CDI)

- Vectorization with these instructions looks like this:

```c
for (int i = 0; i < N; i += 16)
{
    __m512i indices = vload &index_array[i]
    vpconflictd comparisons, indices // comparisons = __m512i
    __mmask to_do = 0xffffffff;

do
{
    vpbroadcastmd tmp, to_do // tmp = __m512i
    vptestnmd mask {to_do}, comparisons, tmp
    do_work(mask); // gather-compute-scatter
    to_do ^= mask;
} while(to_do);
}
```

Do work for element iff no conflicts on remaining earlier elements.
Conflict Detection Instructions (CDI) - Example

1) Compare (for equality) each element in zmm2 with “earlier” elements and output bit vector.

2) Combine bit vector and todo to work out which elements can be updated in this iteration.

3) Loop until todo is 0000.
Conflict Detection Instructions (CDI) – Compiler

- The Intel® compiler (15.0 onwards) will recognise potential run-time conflicts and generate `vpconflict` loops **automatically**:

```c
for (int i = 0; i < N; ++i)
{
    histogram[index[i]]++;
}
```

- Such loops would originally have resulted in:

  remark #15344: loop was not vectorized: vector dependence prevents vectorization
  remark #15346: vector dependence: assumed FLOW dependence between histogram line 22 and histogram line 22
  remark #15346: vector dependence: assumed ANTI dependence between histogram line 22 and histogram line 22

- If you **know** that conflicts cannot occur, you should still specify this: (e.g. `#pragma ivdep`, `#pragma simd`, `#pragma omp simd`)
AVX-512 – Summary

- Performance impact of AVX-512:
  - 2x vector width (vs AVX2)
  - Improved gather/scatter efficiency (vs mov/insertps/extractps sequence and IMCI)
  - Improved control divergence management via masking (vs AVX2)

- Programmability impact of AVX-512:
  - Auto-vectorization of loops with potential dependencies (via vconflict)
  - Improved vectorization of outer loops with complicated flow (via masking)
Preparing for Knights Landing
Preparing for Knights Landing

- 1<sup>st</sup> Knights Landing systems appearing by end of 2015
- How do we prepare for this new processor without it at hand?
- Let's review the main performance-enabling features:
  - Up to 72 cores
  - 2x VPU, AVX-512
  - High-bandwidth MCDRAM
- Plenty of **parallelism** needed for best performance.
Proxies for Knights Landing

- Two pronged approach:

1. Check functional correctness with software tools:
   - Intel® Composer Studio XE 2015 compiles for Knights Landing (-xMIC-AVX512)
   - Intel® Software Development Emulator (SDE) functionally emulates; rough perf. analysis
   - memkind & hbw_malloc will harness MCDRAM

2. Test performance/scalability with the best real-world proxy:
   - Current generation Intel® Xeon Phi™ coprocessor ("Knights Corner")
Intel® Software Development Emulator (SDE)
Freely available instruction emulator:
- http://www.intel.com/software/sde

Intercepts instructions with Pin; allows functional emulation of existing and upcoming ISAs (including AVX-512).
- Execution times may be slow, but the result will be correct.

Produce a profile of the dynamic instruction mix; useful for tuning/assessing vectorization content.
Running SDE

- SDE invocation is very simple:
  
  \$ sde <sde-opt> -- <binary> <command args>

- CPUID is the same as the host (by default) but can be overridden:
  - `knl` for Knights Landing
  - `hsw` for Haswell

- SDE can summarize the types of instructions that were executed:
  
  \$ sde <sde-opt> -omix <output-file> -- <binary> <command args>

- The output file contains lots of information on the instructions executed by the program as seen in the following slides
SDE – Instruction Mix Output File

- Information for each thread in the program:
  - Basic block execution counts, addresses, disassembly, etc.
  - Function-level profile
  - Instruction mix by category, e.g.: category-AVX512
  - Dynamic and static instruction counts
- Global static instruction counts by category
- Global dynamic instruction counts by category
SDE – Basic Block Statistics

ICOUNT: total dynamic instructions executed by this basic block. Basic blocks are sorted by ICOUNT from highest to lowest.

EXECUTIONS: number of times a basic block is invoked.

%: percent of total instructions that come from this basic block.

cumltv%: cumulative % of instruction count up to this basic block.
SDE – Basic Block Statistics

- Look for unpack *ss or *sd instructions (i.e., scalar instructions) in top basic blocks

- Are they SSE, AVX, AVX2, AVX512 instructions?
  - For KNL, we want as many AVX512 instructions as possible
  - Sometimes, non AVX512 instructions come from math libraries and some math functions are not yet optimized for AVX512.

- Are there gathers/scatters (non-unit stride)?
  - Can code be transformed to remove gathers/scatters?
SDE - Summary

- **SDE is good for:**
  - Correctness testing.
  - Investigating instruction inefficiencies (e.g. expensive instruction sequences, poor vectorization, vector length issues)
  - Quantifying expected vector speed-up (i.e. reduction in # instructions)
  - Investigating dynamic mask values.

- **SDE is not good for:**
  - Performance projections.
  - Identifying some performance bottlenecks. Instruction mix gives only counts and does not account for execution bottlenecks (e.g., memory issues).
Hardware as a Performance Proxy
Hardware as a Performance Proxy

- Functional emulation and advanced APIs are invaluable for testing out new instructions and features.
- Performance testing is very important, too.
- How will your code run on Knights Landing?
  - Is it compute-bound? Memory bandwidth-bound?
  - How will the performance features of Knights Landing affect those limits?
- Is there an existing processor that is a good proxy for Knights Landing for your code?
Picking the Right Proxy

- Knights Corner is the best proxy for codes that are:
  - Compute-bound
  - Bandwidth-bound

- Intel® Xeon® processors are the best proxy for codes that are:
  - Limited by memory capacity

- Capacity-limited codes may still benefit from Knights Landing – consider using a reduced problem size for tuning.

<table>
<thead>
<tr>
<th></th>
<th>Intel® Xeon® E5-2696v3</th>
<th>Intel® Xeon Phi™ 7120</th>
<th>Knights Landing</th>
</tr>
</thead>
<tbody>
<tr>
<td>Cores/threads</td>
<td>14/28</td>
<td>61/244</td>
<td>60+/240+</td>
</tr>
<tr>
<td>Nom. Hz</td>
<td>2.6GHz</td>
<td>1.3GHz</td>
<td>N/A</td>
</tr>
<tr>
<td>STREAM BW</td>
<td>~50 GB/s</td>
<td>~170 GB/s</td>
<td>&gt;400 GB/s (MCDRAM)</td>
</tr>
<tr>
<td>SIMD width</td>
<td>256 bits</td>
<td>512 bits</td>
<td>512 bits</td>
</tr>
<tr>
<td>LLC capacity</td>
<td>35MB</td>
<td>30.5MB</td>
<td>30+MB</td>
</tr>
<tr>
<td>DRAM cap.</td>
<td>768GB</td>
<td>16GB</td>
<td>384GB</td>
</tr>
</tbody>
</table>
Picking the Right Proxy – Thread Scaling

Application stops scaling. Could be caused by:
insufficient work; load imbalance; serialization

Results have been estimated or simulated using internal Intel analysis or architecture simulation or modeling, and provided to you for informational purposes. Any differences in your system hardware, software or configuration may affect your actual performance.
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Picking the Right Proxy - Summary

- Knights Corner is almost always the closest proxy to Knights Landing
  - Native execution on KNC = self-hosted KNL
  - Offload to KNC = offload to KNL

- Performance of Knights Corner, like Knights Landing, is driven by:
  - **Thread Scalability**
    (i.e. load balancing, divergence, inter-core communication costs)
  - **Efficient SIMD Vectorization**
    (i.e. data layout/alignment, compiler smarts)
  - **High Bandwidth Memory**
    (i.e. GDDR5)
Performance Optimization
Lessons from Previous Architectures

- **Vectorization:**
  - Avoid cache-line splits; align data structures to 64 bytes.
  - Avoid gathers/scatters; replace with shuffles/permutes for known sequences.
  - Avoid mixing SSE, AVX and AVX512 instructions.

- **Threading:**
  - Ensure that thread affinities are set.
  - Understand affinity and how it affects your application (i.e. which threads share data?).
  - Understand how threads share core resources.

- **Memory:**
  - Tile your algorithm to take advantage of data reuse
  - Layout data to avoid TLB misses (AOS vs. SOA, large pages)
  - Consider the need for software prefetches
  - Understand how threading affects cache and TLB pressure
Nested Parallelism and Locality

- Recall that KNL cores are grouped into tiles, with two cores sharing an L2.

- Effective capacity depends on locality:
  - 2 cores sharing no data => 2 x 512 KB
  - 2 cores sharing all data => 1 x 1 MB

- Ensuring good locality (e.g. through blocking or nested parallelism) is likely to improve performance.

```
#pragma omp parallel for num_threads(ntiles)
for (int i = 0; i < N; ++i)
{
    #pragma omp parallel for num_threads(8)
    for (int j = 0; j < M; ++j)
    {
        ...
    }
}
```
Cluster Modes

- KNL has three on-die cluster modes:
  - All-to-All
  - Quadrant (Default)
  - Sub-NUMA Clustering (SNC)

- SNC exposes each quadrant (9 tiles) as a separate NUMA region.

- Running **one MPI rank per NUMA region** (when in SNC mode) will ensure locality-of-access, and may improve bandwidth.
Summary
Summary

- Knights Landing is a high-throughput successor to Knights Corner:
  - Socketable, bootable processor with access to large amounts of RAM
  - Greatly improved single-thread performance
  - Very high bandwidth, flexible MCDRAM
  - Power-efficient

- Much of Knights Landing’s throughput comes from parallelism:
  - Codes will need to be modernized to fully exploit the features of the chip
  - Knights Corner has parallelism at similar scales and is the best proxy for performance
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